

DR1214 Gerber Details

Boards Details

Number of Layers	6
Board Thickness	1.64mm
Board Material	FR4
Board Finish	Gold Immersion
Copper Weights (Outers)	1.5oz
Copper Weights (Inners)	1oz
Resist Colour	Green
Legend Colour	White
Drill Layer Format	2.4/ABS/INCHS/Leading/Quad

Layer Definitions

File	Description
IpBridge.drd.1516	Drill file buried vias between layer 5 and 6
IpBridge.drd.0215	Drill file buried vias between layer 2 and 5
IpBridge.drd.0116	Drill file vias
IpBridge.drd.0102	Drill file buried vias between layer 1 and 2
Top_copper.cmp	Top copper
Layer_2.gbx	2 nd Layer
Layer_3.gbx	3 rd Layer
Layer_4.gbx	4 th Layer
Layer_5.gbx	5 th Layer
Bottom_copper.gbx	Bottom copper
Top_silkscreen.gbx	Top Silkscreen
Bottom_silkscreen.gbx	Bottom Silkscreen
Top_solder_resist.stc	Top Solder Resist
Bottom_solder_resist.gbx	Bottom Solder Resist
Top_paste_mask.gbx	Top Paste Mask
Bottom_paste_mask.gbx	Bottom Paste Mask

PCB Stackup

L1		foil+plating=20um(min.)
L2	PP: 66.5um+/-20%	foil+plating=20um(min.)
L3		H OZ
L4	CORE: 1100um(含铜)	H OZ
L5	PP: 77.2um+/-20%	foil+plating=20um(min.)
L6	PP: 66.5um+/-20%	foil+plating=20um(min.)
成品板厚: 1600+/-160um(阻焊到阻焊的厚度)		